## NSN 5962-00-150-1150

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-00-150-1150 **Body Length:** Between 1.315 inches and 1.415 inches **Body Width:** Between 0.590 inches and 0.610 inches **Body Height:** Between 0.125 inches and 0.165 inches **Maximum Power Dissipation Rating:** 800.0 milliwatts **Operating Tempurature Range:** -25.0/+85.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and monolithic and negative outputs and programmable and programmed and w/buffered output and w/enable **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 16 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 0.3 volts power source **Memory Device Type:** Rom **Memory Capacity:** Unknown **Test Data Document:** 00752-373729 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 28 printed circuit Shelf Life: N/a **Unit Of Measure: Demilitarization:** 

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Yes - demil/mli